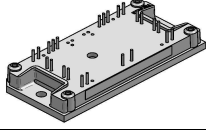
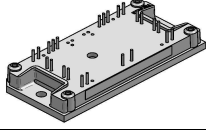
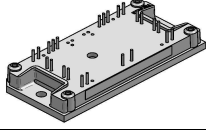
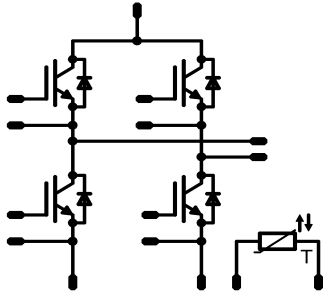
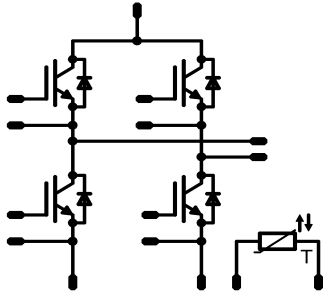
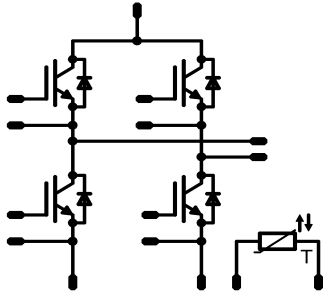


<b>flowPACK 1 H</b>	<b>650V/75A</b>				
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr style="background-color: #000080; color: white;"> <th style="text-align: center; padding: 2px;">Features</th> </tr> <tr> <td style="padding: 2px;"> <ul style="list-style-type: none"> <li>Low inductive 12mm flow1 package</li> <li>H-Bridge topology</li> <li>High-speed IGBT + ultrafast FWD</li> <li>Temperature sensor</li> </ul> </td> </tr> </table>	Features	<ul style="list-style-type: none"> <li>Low inductive 12mm flow1 package</li> <li>H-Bridge topology</li> <li>High-speed IGBT + ultrafast FWD</li> <li>Temperature sensor</li> </ul>	<table border="1" style="width: 100%; border-collapse: collapse;"> <tr style="background-color: #000080; color: white;"> <th style="text-align: center; padding: 2px;">flowPACK 1 H</th> </tr> <tr> <td style="text-align: center; padding: 5px;">  </td> </tr> </table>	flowPACK 1 H	
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<ul style="list-style-type: none"> <li>10-FY064PA075SG-M583F08</li> </ul>					

### Maximum Ratings

$T_j=25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>H-Bridge IGBT</b>				
Collector-emitter break down voltage	$V_{CE}$		650	V
DC collector current	$I_{DC}$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	53 71	A
Pulsed collector current	$I_{Cpulse}$	$t_p$ limited by $T_{jmax}$	225	A
Turn off safe operating area		$V_{CE} \leq 650\text{V}$ , $T_j \leq T_{op max}$	150	A
Power dissipation per IGBT	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	93 141	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150^{\circ}\text{C}$ $V_{GE} = 15\text{V}$	5 400	$\mu\text{s}$ V
Maximum Junction Temperature	$T_{jmax}$		175	$^{\circ}\text{C}$
<b>H-Bridge FWD</b>				
Peak Repetitive Reverse Voltage	$V_{RRM}$	$T_j=25^{\circ}\text{C}$	650	V
DC forward current	$I_F$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	42 55	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	225	A
Power dissipation per Diode	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	70 106	W
Maximum Junction Temperature	$T_{jmax}$		175	$^{\circ}\text{C}$

## Maximum Ratings

$T_j=25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
-----------	--------	-----------	-------	------

### Thermal Properties

Storage temperature	$T_{\text{stg}}$		-40...+125	°C
Operation temperature under switching condition	$T_{\text{op}}$		-40...+( $T_{\text{jmax}}$ - 25)	°C

### Insulation Properties

Insulation voltage	$V_{\text{is}}$	t=2s DC voltage	4000	V
Creepage distance			min 12,7	mm
Clearance			min 12,7	mm
Comparative tracking index	CTI		>200	

## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}[V]$ or $V_{GS}[V]$	$V_r[V]$ or $V_{CE}[V]$ or $V_{DS}[V]$	$I_c[A]$ or $I_F[A]$ or $I_b[A]$	$T_j$	Min	Typ	Max		
<b>H-Bridge IGBT</b>										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,0012	$T_j=25^{\circ}C$ $T_j=150^{\circ}C$	4,2	5,1	5,6	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		75	$T_j=25^{\circ}C$ $T_j=150^{\circ}C$	1,38	1,72 1,97	2,5	V
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	650		$T_j=25^{\circ}C$ $T_j=150^{\circ}C$			15	$\mu A$
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^{\circ}C$ $T_j=150^{\circ}C$			150	nA
Integrated Gate resistor	$R_{gint}$							none		$\Omega$
Turn-on delay time	$t_{d(on)}$	Rgoff=4 $\Omega$ Rgon=4 $\Omega$	$\pm 15$	300	75	$T_j=25^{\circ}C$	85			ns
Rise time	$t_r$					$T_j=150^{\circ}C$	87			
Turn-off delay time	$t_{d(off)}$					$T_j=25^{\circ}C$	14			
						$T_j=150^{\circ}C$	17			
Fall time	$t_f$					$T_j=25^{\circ}C$	125			
						$T_j=150^{\circ}C$	147			
Turn-on energy loss per pulse	$E_{on}$					$T_j=25^{\circ}C$	18			
Turn-off energy loss per pulse	$E_{off}$	$T_j=150^{\circ}C$	31							
Input capacitance	$C_{ies}$	f=1MHz	0	25		$T_j=25^{\circ}C$	0,51			mWs
						$T_j=150^{\circ}C$	0,9			
Reverse transfer capacitance	$C_{rss}$					$T_j=25^{\circ}C$	4620			pF
Gate charge	$Q_{Gate}$		15	480	75	$T_j=25^{\circ}C$		470		nC
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness50um $\lambda = 1 W/mK$						1,02		K/W

## H-Bridge FWD

Diode forward voltage	$V_F$				50	$T_j=25^{\circ}C$ $T_j=125^{\circ}C$	2,4 1,9	3		V
Peak reverse recovery current	$I_{RRM}$	Rgon=4 $\Omega$	$\pm 15$	300	75	$T_j=25^{\circ}C$	63			A
Reverse recovery time	$t_{rr}$					$T_j=150^{\circ}C$	82			
Reverse recovered charge	$Q_{rr}$					$T_j=25^{\circ}C$	17			
						$T_j=150^{\circ}C$	94			
Peak rate of fall of recovery current	$di(rec)max/dt$					$T_j=25^{\circ}C$	0,96			
Reverse recovered energy	Erec					$T_j=150^{\circ}C$	2,94			
						$T_j=25^{\circ}C$	15698			
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness50um $\lambda = 1 W/mK$				$T_j=150^{\circ}C$	5163			K/W

## Thermistor

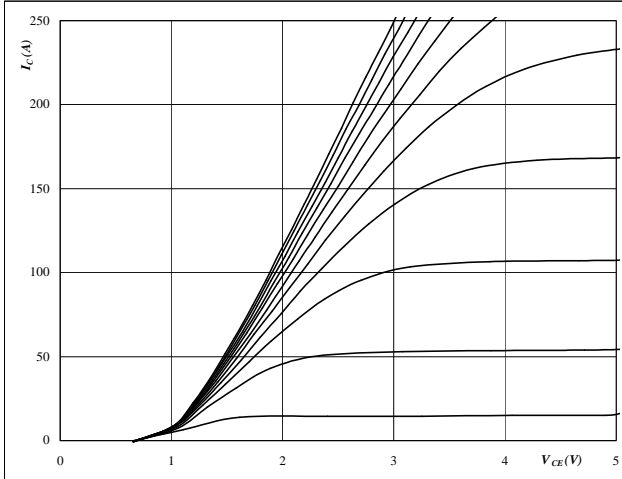
Rated resistance	R					$T=25^{\circ}C$	22000			$\Omega$
Deviation of R25	$\Delta R/R$	R100=1486 $\Omega$				$T=100^{\circ}C$	-5	5		%
Power dissipation	P					$T=25^{\circ}C$	200			mW
Power dissipation constant						$T_j=25^{\circ}C$	2			mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 3\%$				$T_j=25^{\circ}C$	3950			K
B-value	$B_{(25/100)}$	Tol. $\pm 3\%$				$T_j=25^{\circ}C$	3996			K
Vincotech NTC Reference									B	

## Output Inverter

**Figure 1** Output inverter IGBT

**Typical output characteristics**

$I_C = f(V_{CE})$

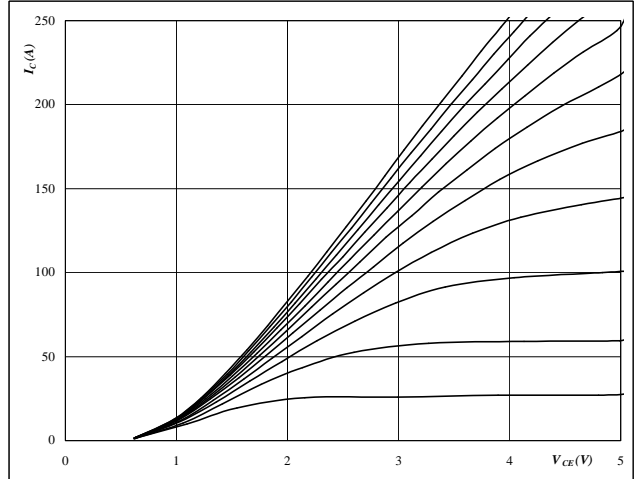


**At**  
 $t_p = 250 \mu s$   
 $T_j = 25 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 2** Output inverter IGBT

**Typical output characteristics**

$I_C = f(V_{CE})$

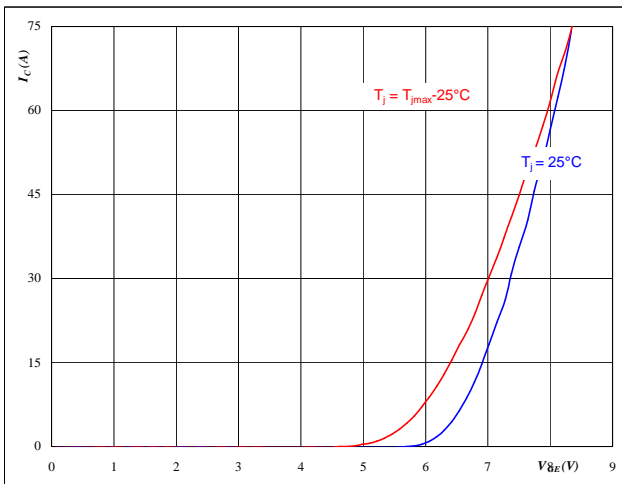


**At**  
 $t_p = 250 \mu s$   
 $T_j = 150 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 3** Output inverter IGBT

**Typical transfer characteristics**

$I_C = f(V_{GE})$

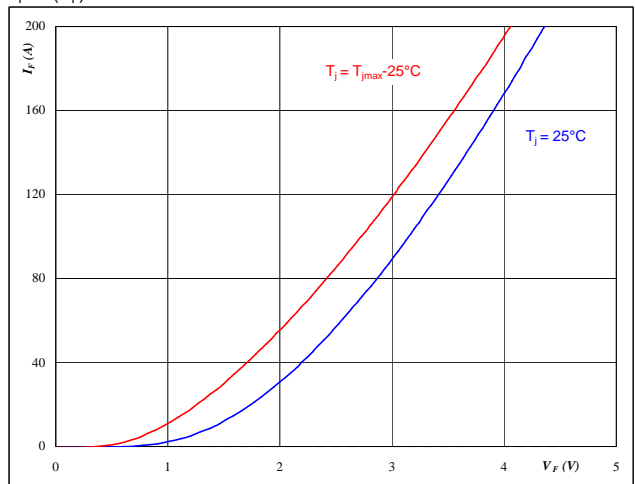


**At**  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 \text{ V}$

**Figure 4** Output inverter FWD

**Typical diode forward current as a function of forward voltage**

$I_F = f(V_F)$



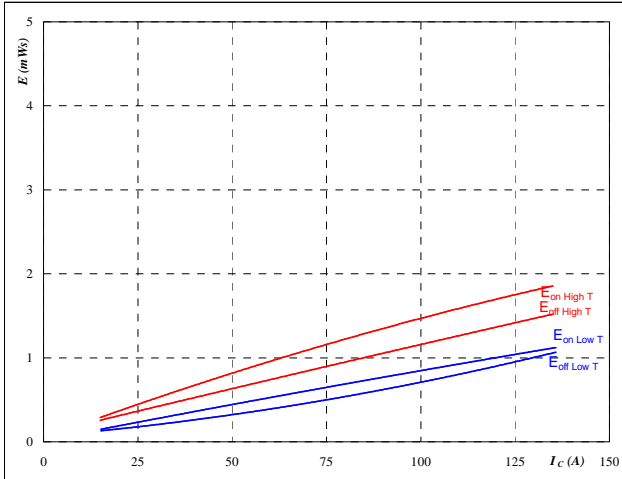
**At**  
 $t_p = 250 \mu s$

## Output Inverter

**Figure 5** Output inverter IGBT

Typical switching energy losses  
as a function of collector current

$$E = f(I_C)$$



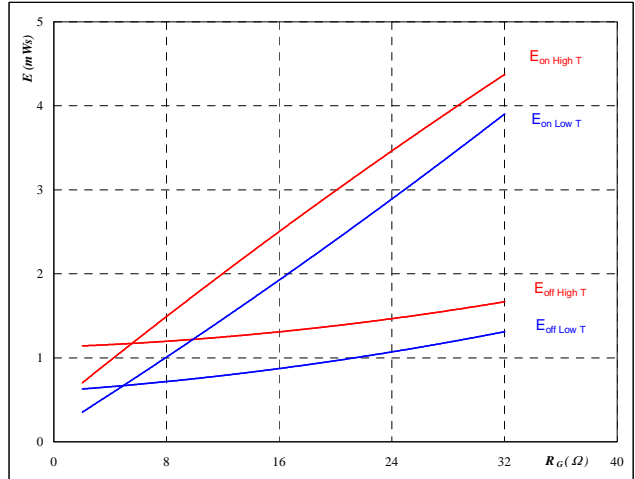
With an inductive load at

$T_j =$	25/150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

**Figure 6** Output inverter IGBT

Typical switching energy losses  
as a function of gate resistor

$$E = f(R_G)$$



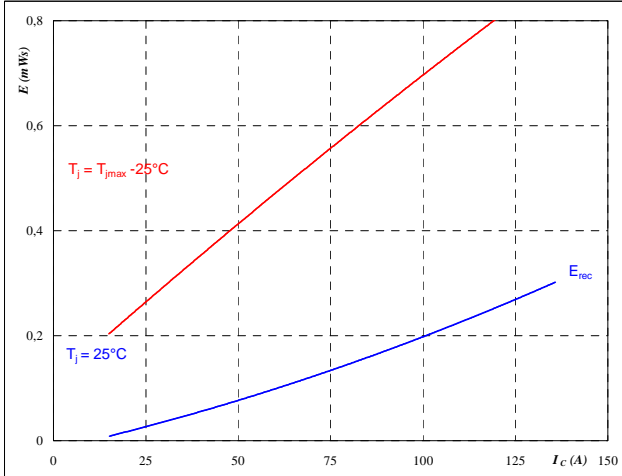
With an inductive load at

$T_j =$	25/150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$I_C =$	75	A

**Figure 7** Output inverter FWD

Typical reverse recovery energy loss  
as a function of collector current

$$E_{rec} = f(I_C)$$



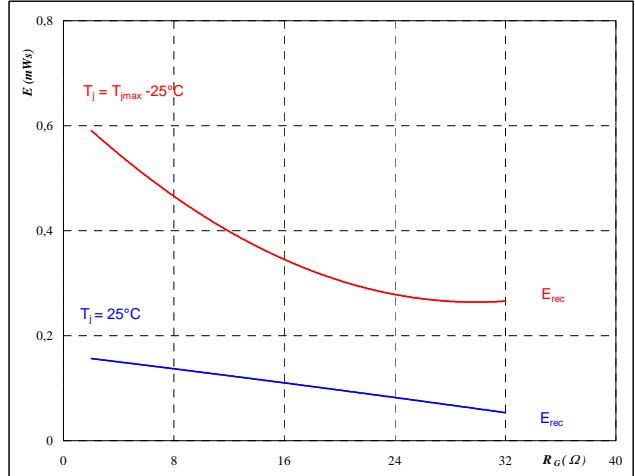
With an inductive load at

$T_j =$	25/150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω

**Figure 8** Output inverter FWD

Typical reverse recovery energy loss  
as a function of gate resistor

$$E_{rec} = f(R_G)$$



With an inductive load at

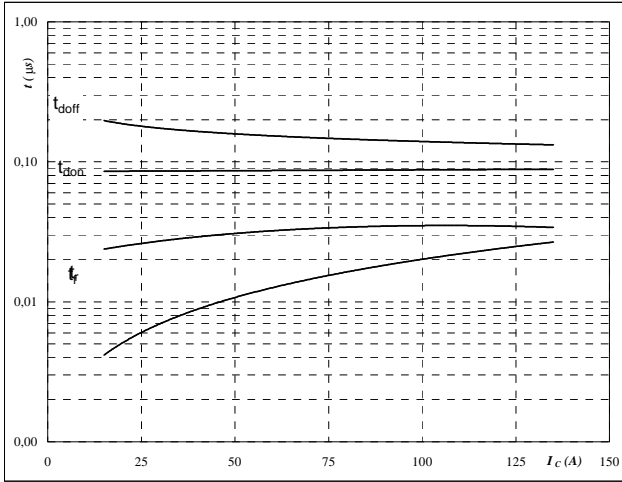
$T_j =$	25/150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$I_C =$	75	A

## Output Inverter

**Figure 9** Output inverter IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



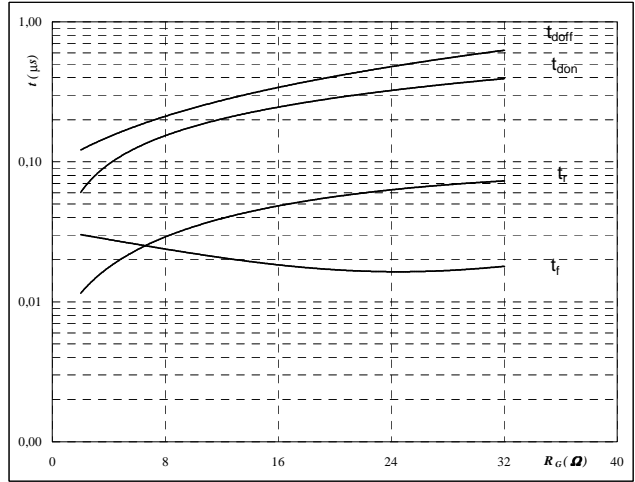
With an inductive load at

$T_J =$	150	$^{\circ}C$
$V_{CE} =$	300	V
$V_{GE} =$	$\pm 15$	V
$R_{gon} =$	4	$\Omega$
$R_{goff} =$	4	$\Omega$

**Figure 10** Output inverter IGBT

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



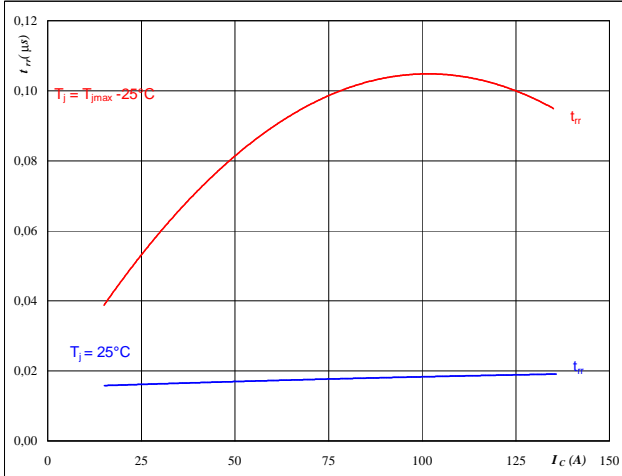
With an inductive load at

$T_J =$	150	$^{\circ}C$
$V_{CE} =$	300	V
$V_{GE} =$	$\pm 15$	V
$I_C =$	75	A

**Figure 11** Output inverter FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



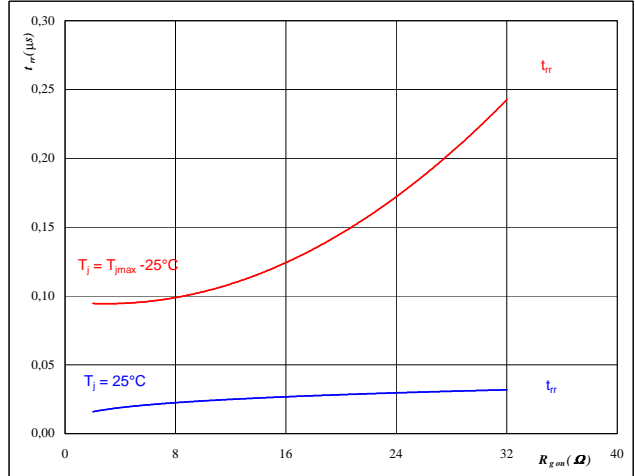
At

$T_J =$	25/150	$^{\circ}C$
$V_{CE} =$	300	V
$V_{GE} =$	$\pm 15$	V
$R_{gon} =$	4	$\Omega$

**Figure 12** Output inverter FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At

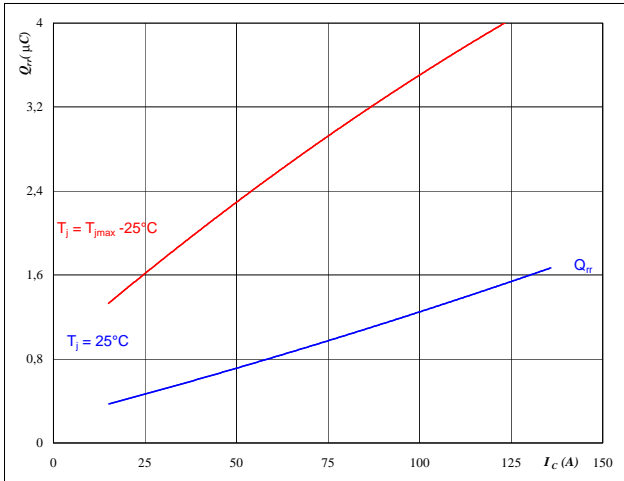
$T_J =$	25/150	$^{\circ}C$
$V_R =$	300	V
$I_F =$	75	A
$V_{GE} =$	$\pm 15$	V

## Output Inverter

Figure 13 Output inverter FWD

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_C)$$

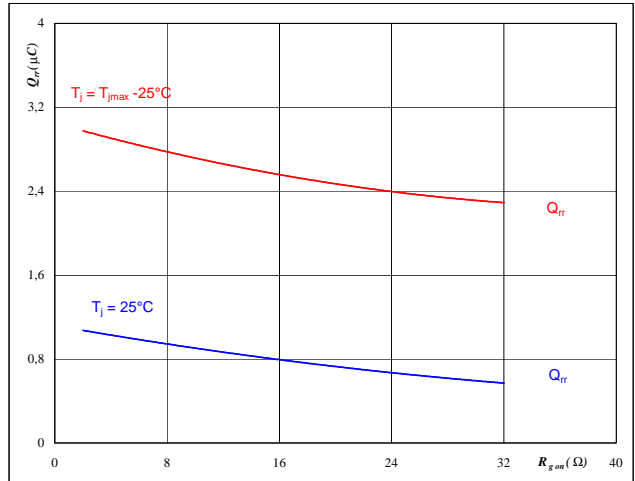


**At**  
 $T_j = 25/150$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 4$  Ω

Figure 14 Output inverter FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

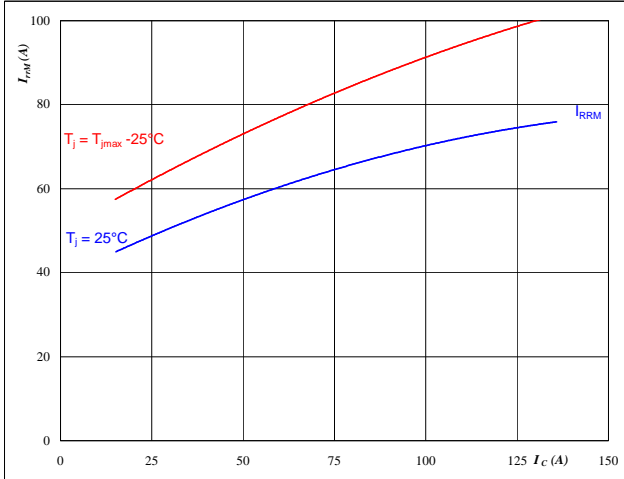


**At**  
 $T_j = 25/150$  °C  
 $V_R = 300$  V  
 $I_F = 75$  A  
 $V_{GE} = \pm 15$  V

Figure 15 Output inverter FWD

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_C)$$

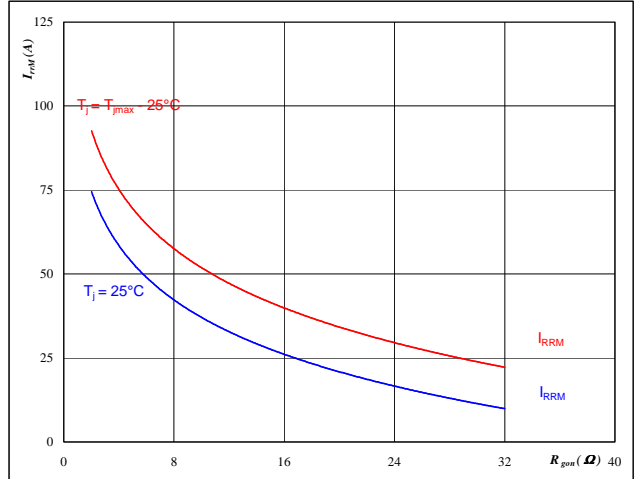


**At**  
 $T_j = 25/150$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 4$  Ω

Figure 16 Output inverter FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$



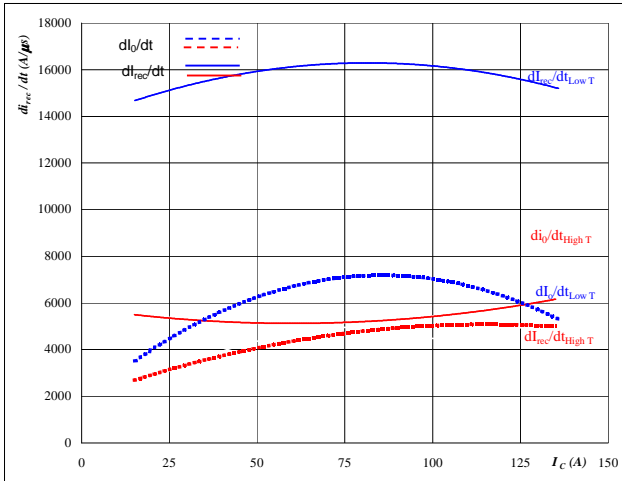
**At**  
 $T_j = 25/150$  °C  
 $V_R = 300$  V  
 $I_F = 75$  A  
 $V_{GE} = \pm 15$  V

## Output Inverter

Figure 17 Output inverter FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$$dI_o/dt, dI_{rec}/dt = f(I_C)$$

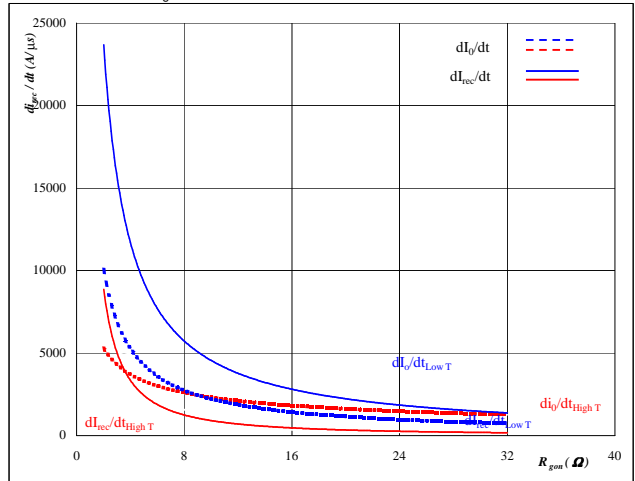


At  
 $T_j = 25/150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 300 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 4 \text{ } \Omega$

Figure 18 Output inverter FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$dI_o/dt, dI_{rec}/dt = f(R_{gon})$$

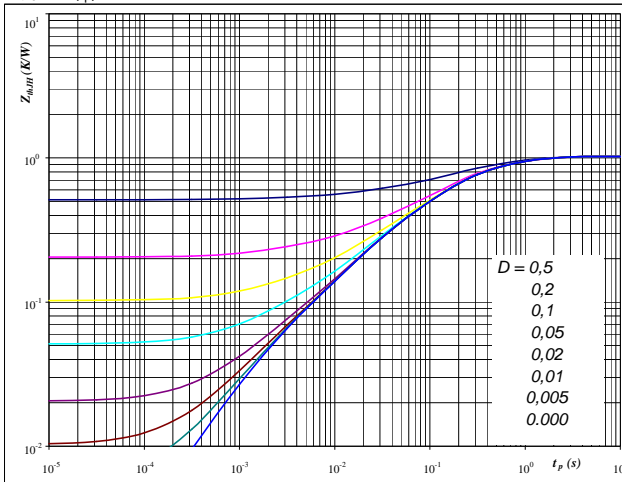


At  
 $T_j = 25/150 \text{ } ^\circ\text{C}$   
 $V_R = 300 \text{ V}$   
 $I_F = 75 \text{ A}$   
 $V_{GE} = \pm 15 \text{ V}$

Figure 19 Output inverter IGBT

IGBT transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$



At  
 $D = t_p / T$   
 $R_{thJH} = 1,02 \text{ K/W} \quad 0,87$

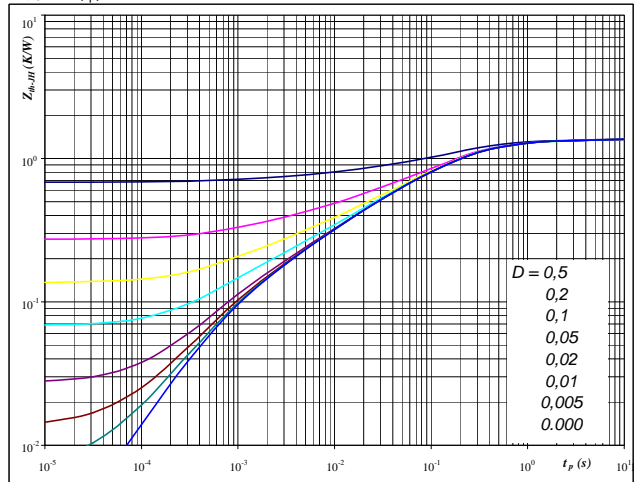
IGBT thermal model values

Thermal grease		Phase change interface	
R (C/W)	Tau (s)	R (C/W)	Tau (s)
0,20	9,7E-01	0,17	8,2E-01
0,49	2,1E-01	0,42	1,8E-01
0,19	6,2E-02	0,16	5,2E-02
0,11	1,4E-02	0,09	1,2E-02
0,03	1,7E-03	0,03	1,4E-03

Figure 20 Output inverter FWD

FWD transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$



At  
 $D = t_p / T$   
 $R_{thJH} = 1,36 \text{ K/W} \quad 1,16$

FWD thermal model values

Thermal grease		Phase change interface	
R (C/W)	Tau (s)	R (C/W)	Tau (s)
0,09	3,0E+00	0,07	2,5E+00
0,40	3,3E-01	0,34	2,8E-01
0,49	9,8E-02	0,41	8,3E-02
0,22	1,7E-02	0,19	1,5E-02
0,10	3,2E-03	0,09	2,8E-03
0,06	6,7E-04	0,05	5,7E-04

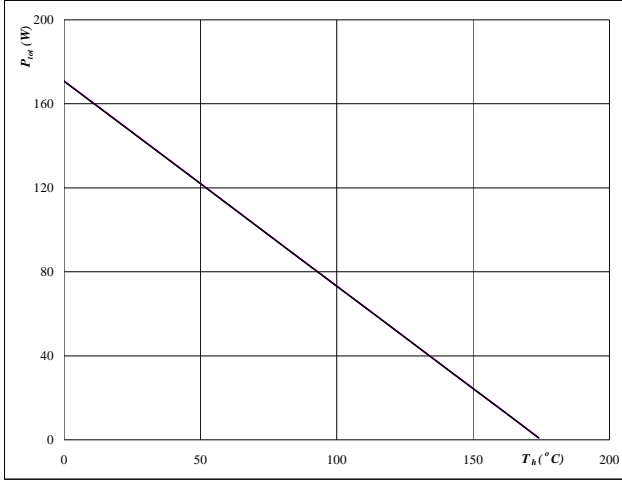


## Output Inverter

Figure 21 Output inverter IGBT

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$

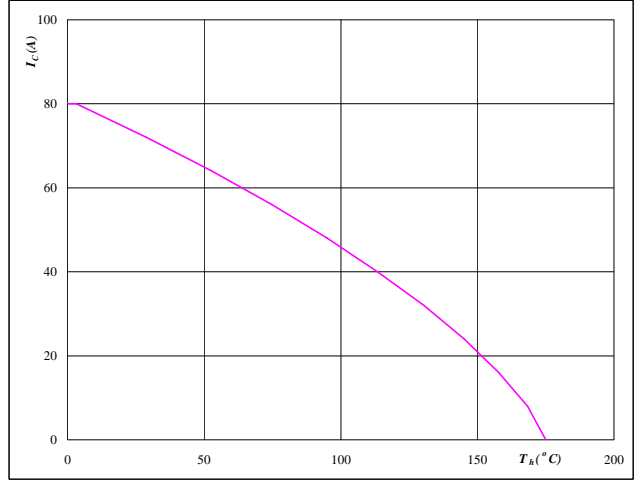


At  
 $T_j = 175$  °C

Figure 22 Output inverter IGBT

Collector current as a function of heatsink temperature

$$I_C = f(T_h)$$

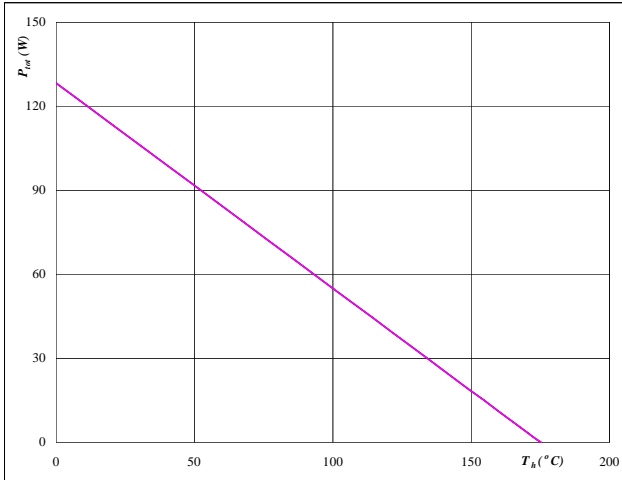


At  
 $T_j = 175$  °C  
 $V_{GE} = 15$  V

Figure 23 Output inverter FWD

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$

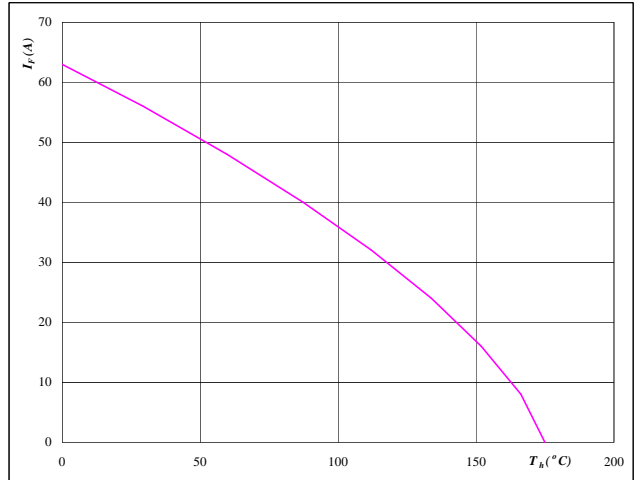


At  
 $T_j = 175$  °C

Figure 24 Output inverter FWD

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$

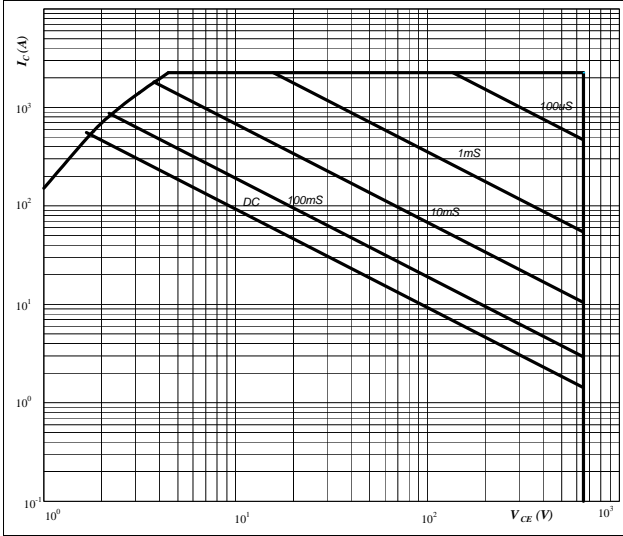


At  
 $T_j = 175$  °C

## Output Inverter

Figure 25 Output inverter IGBT

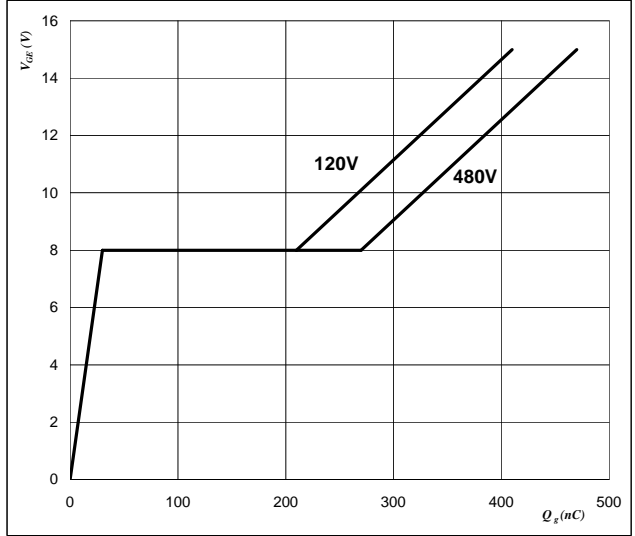
Safe operating area as a function of collector-emitter voltage  
 $I_C = f(V_{CE})$



At  
 D = single pulse  
 $T_h = 80$  °C  
 $V_{GE} = \pm 15$  V  
 $T_j = T_{jmax}$  °C

Figure 26 Output inverter IGBT

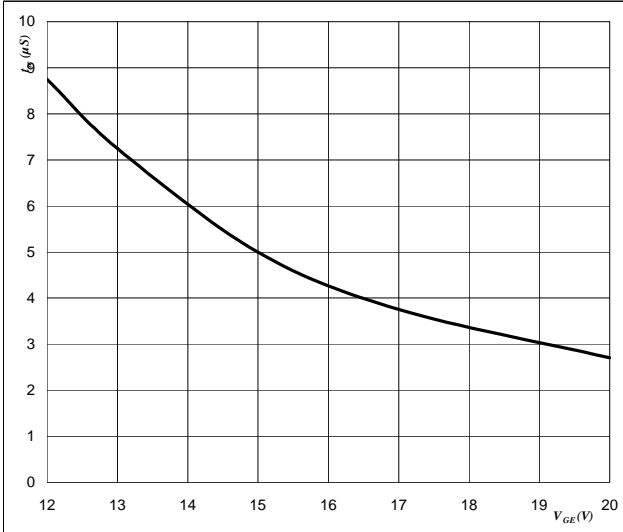
Gate voltage vs Gate charge  
 $V_{GE} = f(Q_{GE})$



At  
 $I_C = 75$  A

Figure 27 Output inverter IGBT

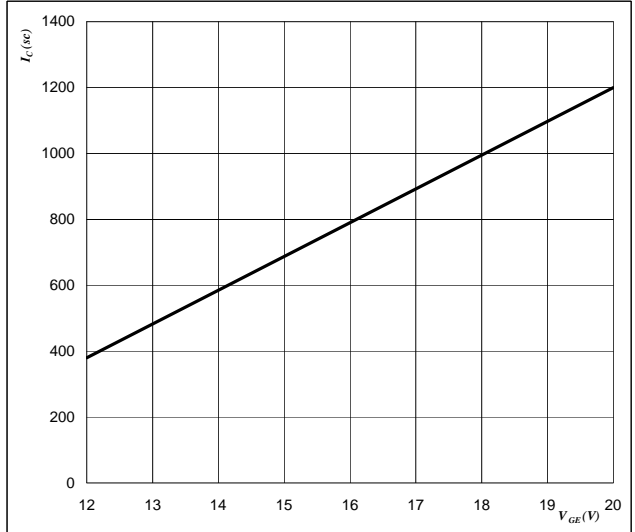
Short circuit withstand time as a function of gate-emitter voltage  
 $t_{sc} = f(V_{GE})$



At  
 $V_{CE} = 400$  V  
 $T_j \leq 150$  °C

Figure 28 Output inverter IGBT

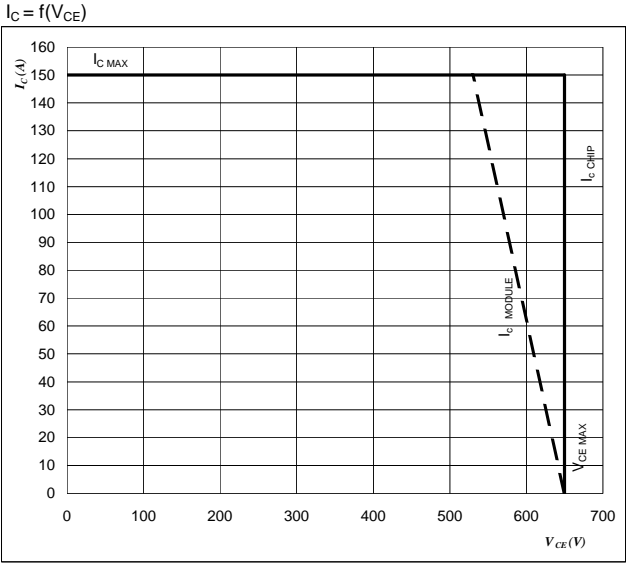
Typical short circuit collector current as a function of gate-emitter voltage  
 $V_{GE} = f(Q_{GE})$



At  
 $V_{CE} \leq 400$  V  
 $T_j = 150$  °C

Figure 29 IGBT

Reverse bias safe operating area



At

$T_J = T_{jmax} - 25 \text{ } ^\circ\text{C}$

Switching mode : 3phase SPWM

### Thermistor

Figure 1 Thermistor

Typical NTC characteristic as a function of temperature

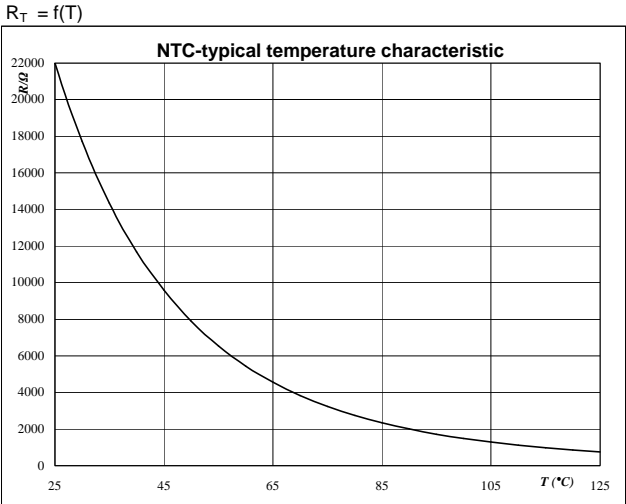


Figure 2 Thermistor

Typical NTC resistance values

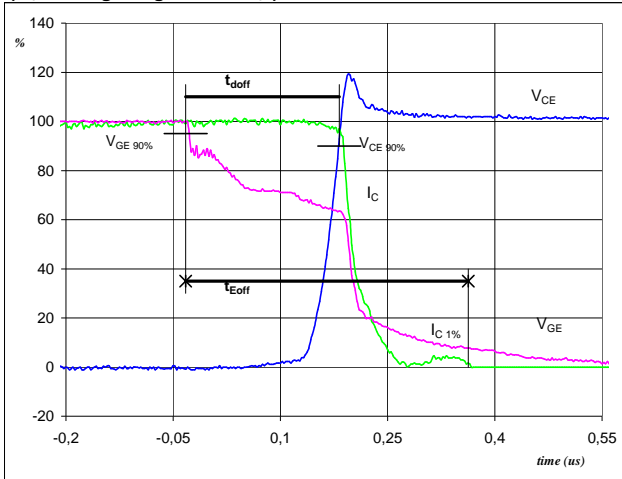
$$R(T) = R_{25} \cdot e^{\left( B_{25/100} \left( \frac{1}{T} - \frac{1}{T_{25}} \right) \right)} \quad [\Omega]$$

## Switching Definitions Output Inverter

General conditions	
$T_j$	= 150 °C
$R_{gon}$	= 8 Ω
$R_{goff}$	= 8 Ω

Figure 1 Output inverter IGBT

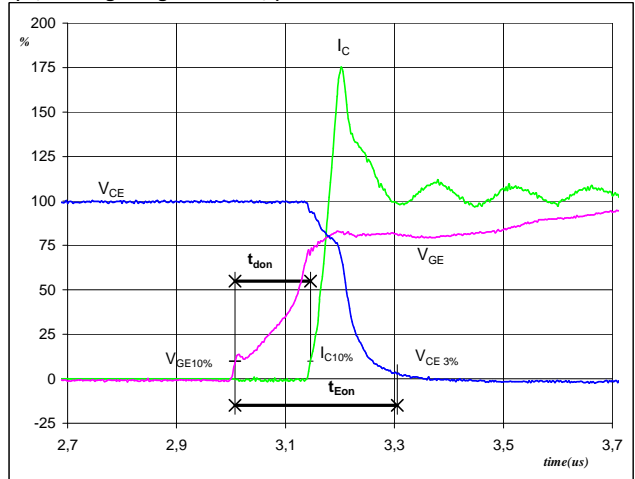
Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$   
 ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	300	V
$I_C(100\%) =$	75	A
$t_{doff} =$	0,21	μs
$t_{Eoff} =$	0,40	μs

Figure 2 Output inverter IGBT

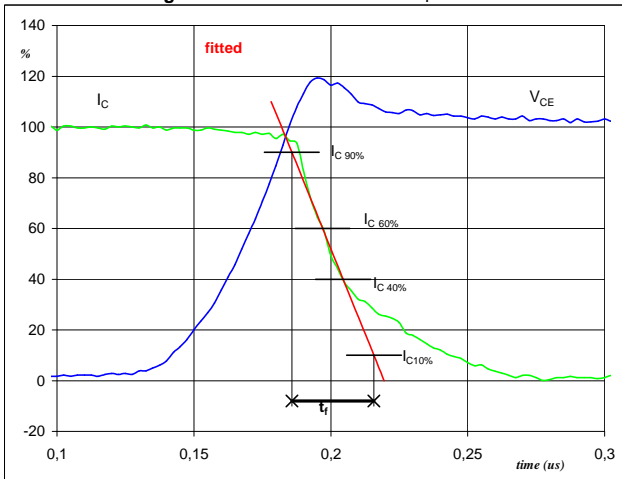
Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$   
 ( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	300	V
$I_C(100\%) =$	75	A
$t_{don} =$	0,14	μs
$t_{Eon} =$	0,30	μs

Figure 3 Output inverter IGBT

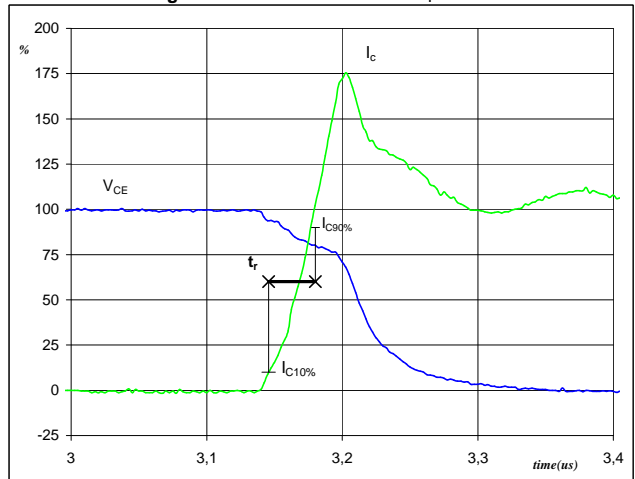
Turn-off Switching Waveforms & definition of  $t_f$



$V_C(100\%) =$	300	V
$I_C(100\%) =$	75	A
$t_f =$	0,03	μs

Figure 4 Output inverter IGBT

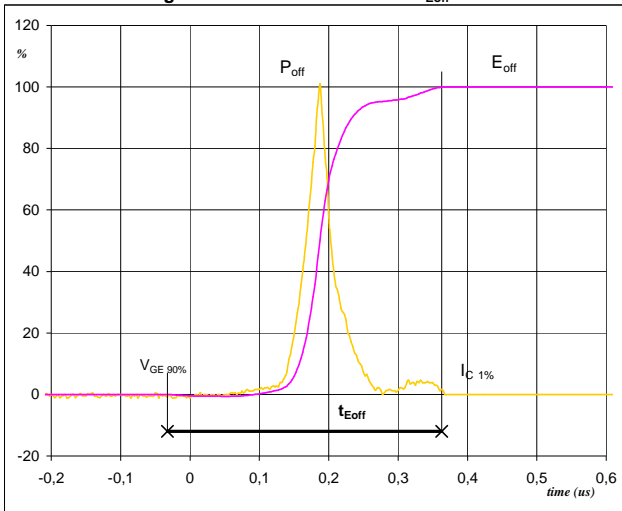
Turn-on Switching Waveforms & definition of  $t_r$



$V_C(100\%) =$	300	V
$I_C(100\%) =$	75	A
$t_r =$	0,03	μs

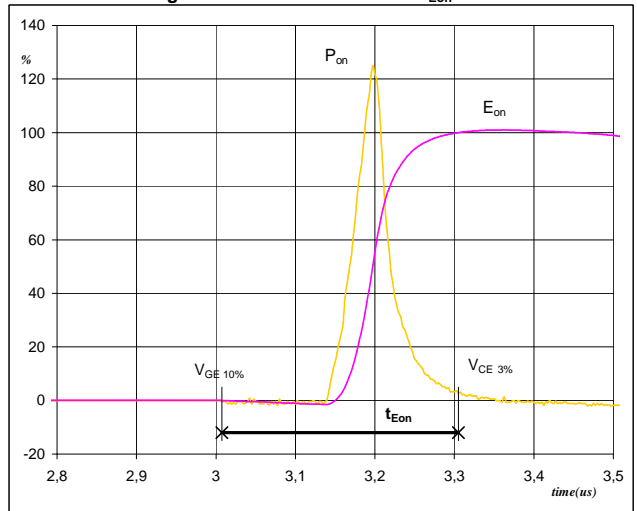
## Switching Definitions Output Inverter

**Figure 5** Output inverter IGBT  
Turn-off Switching Waveforms & definition of  $t_{Eoff}$



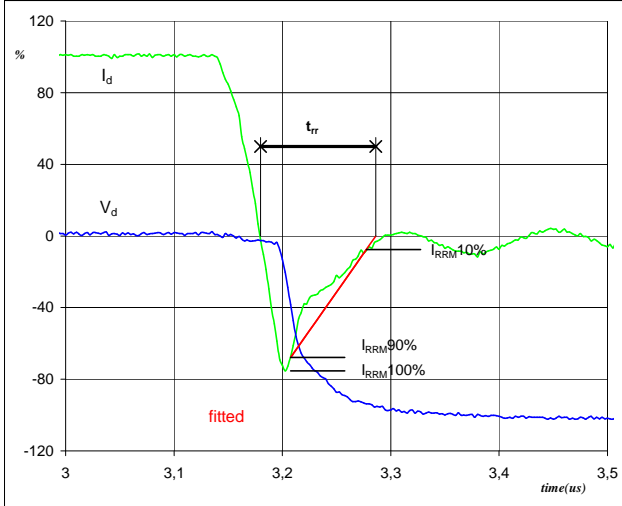
$P_{off} (100\%) = 22,61 \text{ kW}$   
 $E_{off} (100\%) = 1,15 \text{ mJ}$   
 $t_{Eoff} = 0,40 \text{ }\mu\text{s}$

**Figure 6** Output inverter IGBT  
Turn-on Switching Waveforms & definition of  $t_{Eon}$



$P_{on} (100\%) = 22,61 \text{ kW}$   
 $E_{on} (100\%) = 1,52 \text{ mJ}$   
 $t_{Eon} = 0,30 \text{ }\mu\text{s}$

**Figure 7** Output inverter IGBT  
Turn-off Switching Waveforms & definition of  $t_{rr}$

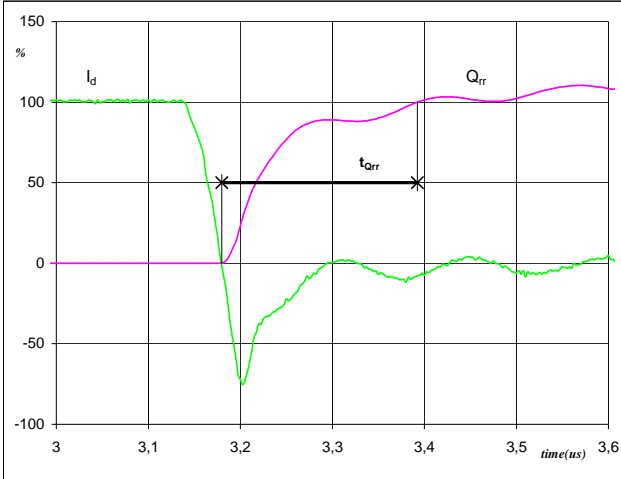


$V_d (100\%) = 300 \text{ V}$   
 $I_d (100\%) = 75 \text{ A}$   
 $I_{RRM} (100\%) = -57 \text{ A}$   
 $t_{rr} = 0,11 \text{ }\mu\text{s}$

## Switching Definitions Output Inverter

Figure 8 Output inverter FWD

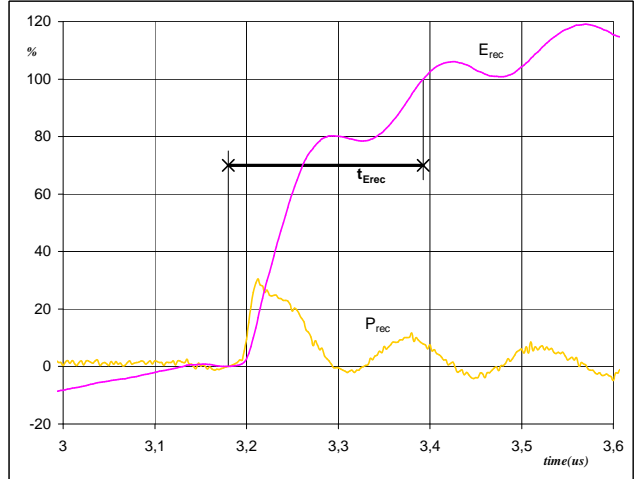
Turn-on Switching Waveforms & definition of  $t_{Qrr}$   
 ( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )



$I_d$ (100%) =	75	A
$Q_{rr}$ (100%) =	2,94	$\mu C$
$t_{Qrr}$ =	0,21	$\mu s$

Figure 9 Output inverter FWD

Turn-on Switching Waveforms & definition of  $t_{Erec}$   
 ( $t_{Erec}$  = integrating time for  $E_{rec}$ )



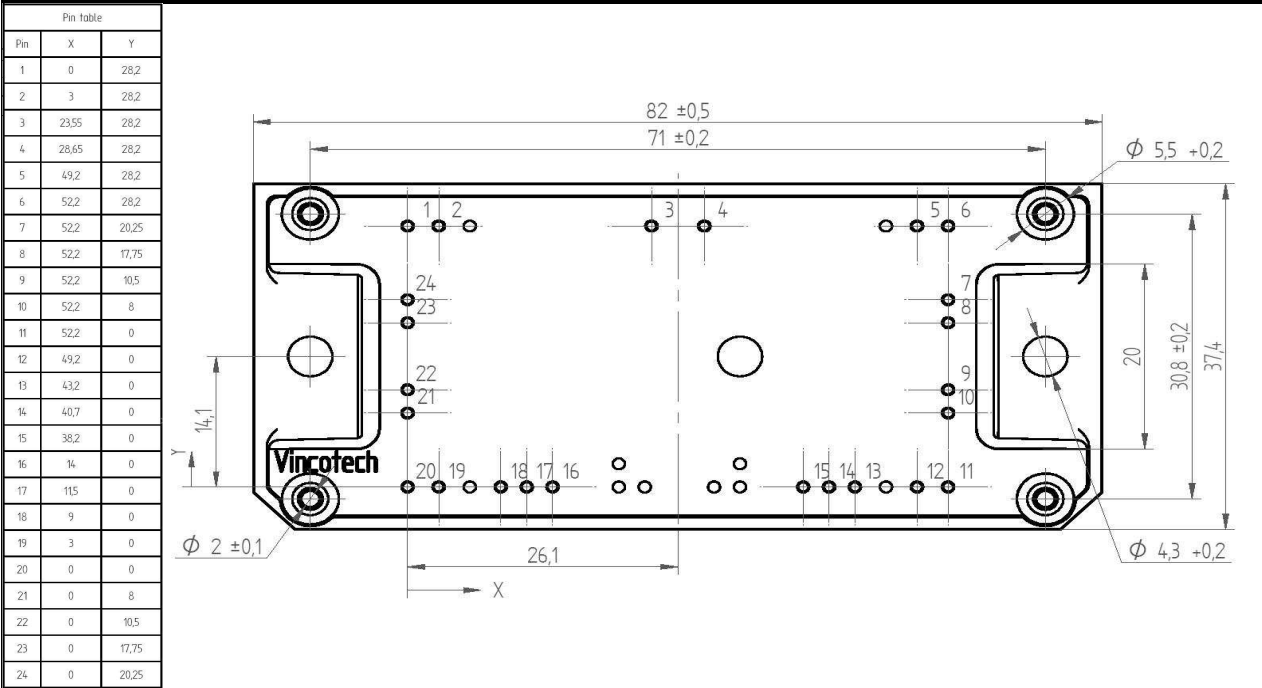
$P_{rec}$ (100%) =	22,61	kW
$E_{rec}$ (100%) =	0,50	mJ
$t_{Erec}$ =	0,21	$\mu s$

### Ordering Code and Marking - Outline - Pinout

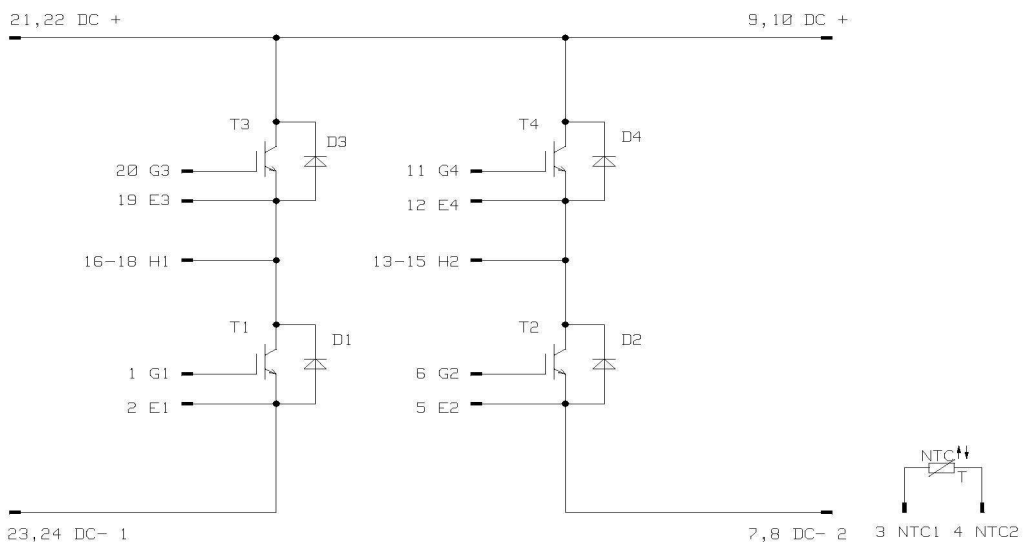
#### Ordering Code & Marking

Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste 12mm housing	10-FY064PA075SG-M583F08	M583F08	M583F08

#### Outline



#### Pinout



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